

# S-19316 Series

# AUTOMOTIVE, 125°C OPERATION, 36 V INPUT, 40 mA VOLTAGE REGULATOR WITH INPUT MONITORING RESET FUNCTION

www.ablic.com

© ABLIC Inc., 2020

Rev.1.1 00

The S-19316 Series, developed by using high-withstand voltage CMOS process technology, is a positive voltage regulator with the reset function, which has high-withstand voltage and low current consumption.

Regarding a release signal output in the reset function, the S-19316 Series enables delay time adjustment by an external capacitor. Output form of the reset function is selectable from Nch open-drain output or CMOS output.

ABLIC Inc. offers a "thermal simulation service" which supports the thermal design in conditions when our power management ICs are in use by customers. Our thermal simulation service will contribute to reducing the risk in the thermal design at customers' development stage.

ABLIC Inc. also offers FIT rate calculated based on actual customer usage conditions in order to support customer functional safety design.

Contact our sales representatives for details.

# Caution This product can be used in vehicle equipment and in-vehicle equipment. Before using the product for these purposes, it is imperative to contact our sales representatives.

A type: B type:

3.0 V to 36.0 V

1.0 V to 5.3 V, selectable in 0.1 V step

1.8 V to 5.3 V, selectable in 0.1 V step

Possible to output 40 mA (1.0 V  $\leq$  V<sub>OUT(S)</sub> < 2.0 V, V<sub>IN</sub>  $\geq$  4.0 V)<sup>\*1</sup>

Possible to output 40 mA (2.0 V  $\leq$  V<sub>OUT(S)</sub>  $\leq$  5.3 V, V<sub>IN</sub> = V<sub>OUT(S)</sub> + 2.0 V)<sup>\*1</sup>

 $5.0\% \le V_{HYS} \le 30.0\%$  (T<sub>j</sub> =  $-40^{\circ}C$  to  $+125^{\circ}C$ )

 $\pm 0.03 \text{ V} (1.0 \text{ V} \le V_{\text{OUT}(S)} < 1.5 \text{ V}, \text{ T}_{j} = -40^{\circ}\text{C to} + 125^{\circ}\text{C})$ 

 $\pm 2.0\%$  (1.5 V  $\leq$  V<sub>OUT(S)</sub>  $\leq$  5.3 V, T<sub>j</sub> = -40°C to +125°C)

A ceramic capacitor can be used. (1.0  $\mu$ F or more)

 $V_{HYS} = 0\%$ 

240 mV typ. (Vout(s) = 5.0 V, lout = 30 mA)

Limits overcurrent of output transistor

3.0 V to 11.3 V, selectable in 0.1 V step

 $\pm 20\%$  (C<sub>D</sub> = 3.3 nF, T<sub>j</sub> =  $-40^{\circ}$ C to  $+125^{\circ}$ C)

Detection temperature 160°C typ.

A type: 1.8 V to 36.0 V B type: 2.5 V to 36.0 V

Nch open-drain output

"Available":

"Unavailable":

CMOS output

 $\pm 2.0\%$  (T<sub>i</sub> = -40°C to +125°C)

# Features

**Regulator block** 

- Output voltage:
- Input voltage:
- Output voltage accuracy:
- Dropout voltage:
- Output current:
- Input and output capacitors:
- Built-in overcurrent protection circuit:
- Built-in thermal shutdown circuit:

#### **Detector block**

- Detection voltage:
- Operation voltage:
- Detection voltage accuracy:
- Hysteresis width selectable from "Available" / "Unavailable":
- Release delay time accuracy:
- Output form:

#### Overall

- Current consumption:
- Operation temperature range:
- Lead-free (Sn 100%), halogen-free
- Withstand 45 V load dump
- AEC-Q100 qualified\*2

2.2  $\mu$ A typ. (T<sub>j</sub> = -40°C to +125°C) Ta = -40°C to +125°C

- \*1. Please make sure that the loss of the IC will not exceed the power dissipation when the output current is large.
- **\*2.** Contact our sales representatives for details.

# Applications

- Constant-voltage power supply and battery monitoring circuit for automotive electric component
- Power supply and battery monitoring circuit for low-current battery-powered device

# Packages

- SOT-89-5
- HTMSOP-8
- SOT-23-5

# Block Diagrams

1. S-19316 Series A type



Figure 1

2. S-19316 Series B type



\*1. Parasitic diode

Figure 2

# ■ AEC-Q100 Qualified

This IC supports AEC-Q100 for operation temperature grade 1. Contact our sales representatives for details of AEC-Q100 reliability specification.

# Product Name Structure

Users can select the product type, output voltage, detection voltage, release voltage, and package type for the S-19316 Series. Refer to "1. Product name" regarding the contents of product name, "3. Packages" regarding the package drawings.

#### 1. Product name



- **\*1.** Refer to the tape drawing.
- \*2. Contact our sales representatives for details on combination of output voltage, detection voltage, and release voltage.
- \*3. Refer to "2. Function list of product type".

# AUTOMOTIVE, 125°C OPERATION, 36 V INPUT, 40 mA VOLTAGE REGULATOR WITH INPUT MONITORING RESET FUNCTION S-19316 Series Rev. 1.1\_00

**Remark 1.** The output voltage (V<sub>OUT</sub>) can be set in a range which satisfies the following conditions.

- Set output voltage (V<sub>OUT(S)</sub>) is 100 mV step
- A type:  $1.0 \text{ V} \leq V_{\text{OUT}(S)} \leq 5.3 \text{ V}$
- B type:  $1.8 \text{ V} \le V_{\text{OUT}(S)} \le 5.3 \text{ V}$
- 2. The detection voltage (–V<sub>DET</sub>) can be set in a range which satisfies the following conditions.
  - Set detection voltage (-V<sub>DET(S)</sub>) is 100 mV step
  - 3.0 V  $\leq -V_{\text{DET}(S)} \leq 11.3$  V
- **3.** The release voltage (+V<sub>DET</sub>) can be set in a range which satisfies the following conditions. Release voltage possible setting range is shown in **Figure 3**.
  - Set release voltage  $(+V_{DET(S)})$  is 100 mV step
  - 5.0%  $\leq V_{HYS} \leq 30.0\%$



Figure 3 Release Voltage Possible Setting Area

If hysteresis width "Unavailable" was selected,  $+V_{DET} = -V_{DET}$ .

#### 2. Function list of product type

	Table 1	
Product Type	RO Pin Output Form	RO Pin Output Logic
А	Nch open-drain output	Active "L"
В	CMOS output	Active "L"

#### 3. Packages

#### Table 2 Package Drawing Codes

Package Name	Dimension	Таре	Reel	Land
SOT-89-5	UP005-A-P-SD	UP005-A-C-SD	UP005-A-R-SD	-
HTMSOP-8	FP008-A-P-SD	FP008-A-C-SD	FP008-A-R-SD	FP008-A-L-SD
SOT-23-5	MP005-A-P-SD	MP005-A-C-SD	MP005-A-R-SD	_

# ■ Pin Configurations

## 1. SOT-89-5



Table 3					
Pin No.	Symbol	Description			
1	CD	Connection pin for delay time adjustment capacitor			
2	VSS	GND pin			
3	VIN	Input voltage pin			
4	VOUT	Output voltage pin			
5	RO	Reset output pin			

#### Figure 4

# 2. HTMSOP-8



Table 4					
Pin No.	Symbol	Description			
1	NC <sup>*2</sup>	No connection			
2	VOUT	Output voltage pin			
3	RO	Reset output pin			
4	NC*2	No connection			
5	CD	Connection pin for delay time adjustment capacitor			
6	VSS	GND pin			
7	NC*2	No connection			
8	VIN	Input voltage pin			

Figure 5

- \*1. Connect the heat sink of backside at shadowed area to the board, and set electric potential GND. However, do not use it as the function of electrode.
- \*2. The NC pin is electrically open. The NC pin can be connected to the VIN pin or the VSS pin.

#### 3. SOT-23-5

Тор у	view	
5 _ <u>日</u>	4 日	
日日 12		

Figure 6

Table 5					
Pin No.	Symbol Description				
1	RO	Reset output pin			
2	VSS	GND pin			
3	VOUT	Output voltage pin			
4	VIN	Input voltage pin			
5	CD	Connection pin for delay time adjustment capacitor			

# ■ Absolute Maximum Ratings

			(Ta = +25°C unless otherwise s	specified)
	ltem	Symbol	Absolute Maximum Rating	Unit
Input voltage		VIN	$V_{\text{SS}} - 0.3$ to $V_{\text{SS}} + 45.0$	V
Output voltage		Vout	$V_{SS}-0.3$ to $V_{IN}+0.3 \leq V_{SS}+7.0$	V
Nch open-drain outp		N/	$V_{SS} - 0.3$ to $V_{SS} + 45.0$	V
RO pin voltage	CMOS output	V <sub>RO</sub>	$V_{\text{SS}} - 0.3$ to $V_{\text{OUT}} + 0.3 \leq V_{\text{SS}} + 7.0$	V
CD pin voltage		Vcd	$V_{SS}-0.3$ to $V_{IN}+0.3 \leq V_{SS}+7.0$	V
Output current (Re	gulator block)	Іоит	52	mA
	Nch open-drain output	IRON	20	mA
Output current	CMOS output	IRON	20	mA
(Detector block)	CMOS output	IROP	-20	mA
Junction temperature		Tj	-40 to +150	°C
Operation ambient	temperature	T <sub>opr</sub>	-40 to +125	°C
Storage temperatu	Ire	T <sub>stg</sub>	-40 to +150	°C

Table 6

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

# Thermal Resistance Value

		Table 7					
Item	Symbol	Condit	ion	Min.	Тур.	Max.	Unit
			Board A	_	119	_	°C/W
			Board B	-	84	_	°C/W
		SOT-89-5	Board C	-	_	_	°C/W
			Board D	_	46	_	°C/W
			Board E	_	35	_	°C/W
			Board A	-	159	_	°C/W
			Board B	-	113	_	°C/W
Junction-to-ambient thermal resistance*1	θја	HTMSOP-8	Board C	_	39	_	°C/W
			Board D	_	40	_	°C/W
			Board E	-	30	_	°C/W
			Board A	_	192	_	°C/W
			Board B	-	160	_	°C/W
		SOT-23-5	Board C		_	_	°C/W
			Board D		_	_	°C/W
			Board E	_	_	-	°C/W

\*1. Test environment: compliance with JEDEC STANDARD JESD51-2A

**Remark** Refer to "**■ Power Dissipation**" and "**Test Board**" for details.

Table 8

# Electrical Characteristics

#### 1. Regulator block

			(T <sub>j</sub> = -40°0	C to +12	5°C unle	ss other	wise sp	ecified)
Item	Symbol	Con	dition	Min.	Тур.	Max.	Unit	Test Circuit
Output valte re*1		$V_{IN} = V_{OUT(S)} + 2.0 V,$	$1.0~V \leq V_{OUT(S)} < 1.5~V$	V <sub>OUT(S)</sub> - 0.03	V <sub>OUT(S)</sub>	V <sub>OUT(S)</sub> + 0.03	V	1
Output voltage*1	V <sub>OUT(E)</sub>	I <sub>OUT</sub> = 1 mA	$1.5~V \leq V_{OUT(S)} \leq 5.3~V$	$\begin{array}{c} V_{\text{OUT(S)}} \\ \times \ 0.98 \end{array}$	V <sub>OUT(S)</sub>	$V_{OUT(S)}  imes 1.02$	V	1
Outrout ourrout*2		V <sub>IN</sub> = 4.0 V	$1.0 \text{ V} \le V_{\text{OUT}(S)} < 2.0 \text{ V}$	40*4	-	-	mA	2
Output current*2	IOUT	$V_{IN} = V_{OUT(S)} + 2.0 V$	$2.0~V \leq V_{OUT(S)} \leq 5.3~V$	40 <sup>*4</sup>	-	_	mA	2
			$1.0~V \leq V_{OUT(S)} < 1.5~V$	2.00	2.19	2.38	V	1
			$1.5~V \leq V_{OUT(S)} < 2.0~V$	1.50	1.73	1.95	V	1
Dropout voltogo*3	M.	$l_{\rm m} = 20 \mathrm{m}$	$2.0~V \leq V_{\text{OUT}(S)} < 2.5~V$	1.00	1.19	1.39	V	1
Dropout voltage*3	Vdrop	Ιουτ = 30 mA	$2.5~V \leq V_{OUT(S)} < 3.0~V$	0.50	0.66	0.82	V	1
			$3.0~V \leq V_{OUT(S)} < 4.0~V$	-	0.35	0.60	V	1
			$4.0~V \leq V_{\text{OUT}(S)} \leq 5.3~V$	-	0.24	0.45	V	1
Line regulation	$\frac{\Delta V_{\text{OUT1}}}{\Delta V_{\text{IN}} \bullet V_{\text{OUT}}}$	$V_{OUT(S)} + 2.0 \ V \leq V_{IN} \leq 3$	6.0 V, I <sub>OUT</sub> = 1 mA	-	0.01	0.2	%/V	1
		V <sub>IN</sub> = 4.0 V, 1 µA ≤ I <sub>OUT</sub> ≤ 30 mA	$1.0 \ V \le V_{OUT(S)} < 2.0 \ V$	_	24	45	mV	1
Load regulation	$\Delta V_{OUT2}$	$\label{eq:VIN} \begin{split} V_{\text{IN}} &= V_{\text{OUT}(S)} + 2.0 \text{ V}, \\ 1 \ \mu\text{A} \leq I_{\text{OUT}} \leq 30 \text{ mA} \end{split}$	$2.0~V \leq V_{OUT(S)} \leq 5.3~V$	-	24	45	mV	1
Input voltage	VIN	-	_	3.0	-	36.0	V	-
		V <sub>IN</sub> = 4.0 V, V <sub>OUT</sub> = 0 V	$1.0 \ V \le V_{OUT(S)} < 2.0 \ V$	_	24	-	mA	2
Short-circuit current	Ishort	$V_{IN} = V_{OUT(S)} + 2.0 \text{ V},$ $V_{OUT} = 0 \text{ V}$	$2.0~V \leq V_{OUT(S)} \leq 5.3~V$	-	24	-	mA	2
Thermal shutdown detection temperature	Tsd	Junction temperature		_	160	-	°C	_
Thermal shutdown release temperature	T <sub>SR</sub>	Junction temperature		-	135	-	°C	-

\*1. V<sub>OUT(S)</sub>: Set output voltage

 $V_{\text{OUT}(\text{E})}$ : Actual output voltage

Output voltage when fixing  $I_{OUT}$  (= 1 mA) and inputting  $V_{OUT(S)}$  + 2.0 V

\*2. The output current at which the output voltage becomes 95% of V<sub>OUT(E)</sub> after gradually increasing the output current.

\*3. V<sub>drop</sub> = V<sub>IN1</sub> - (V<sub>OUT3</sub> × 0.98)

 $V_{IN1}$  is the input voltage at which the output voltage becomes 98% of  $V_{OUT3}$  after gradually decreasing the input voltage.

 $V_{OUT3}$  is the output voltage when  $V_{IN}$  = 4.0 V (1.0 V  $\leq V_{OUT(S)} <$  2.0 V), or  $V_{IN}$  =  $V_{OUT(S)} +$  2.0 V (2.0 V  $\leq V_{OUT(S)} \leq$  5.3 V), and  $I_{OUT}$  = 30 mA

\*4. Due to limitation of the power dissipation, this value may not be satisfied. Attention should be paid to the power dissipation when the output current is large.
This enables if each is more than the design.

This specification is guaranteed by design.

Table 9

#### 2. Detector block

			(T <sub>j</sub> = -40°	°C to +125	5°C unles	s otherwi	se spe	ecified)
Item	Symbol	Condition		Min.	Тур.	Max.	Unit	Test Circuit
Detection voltage <sup>*1</sup>	-Vdet	_		$-V_{DET(S)} \times 0.98$	-V <sub>DET(S)</sub>	$\begin{array}{c} -V_{\text{DET(S)}} \\ \times \ 1.02 \end{array}$	v	3
Deleges valters*2	+Vdet	V <sub>HYS</sub> = 0%		$-V_{DET(S)} \times 0.98$	-V <sub>DET(S)</sub>	$\begin{array}{c} -V_{\text{DET(S)}} \\ \times \ 1.02 \end{array}$	V	3
Release voltage <sup>*2</sup>	+VDET	$5.0\% \leq V_{HYS} \leq 30.0\%$		$+V_{DET(S)} \times 0.98$	+V <sub>DET(S)</sub>	$\begin{array}{c} +V_{\text{DET(S)}} \\ \times \ 1.02 \end{array}$	v	3
Operation voltage	Vopr	S-19316 Series A type		1.8	-	36.0	V	-
Operation voltage	VOPR	S-19316 Series B type		2.5	-	36.0	V	_
Output current "H"	IROP	CMOS output, $V_{DS}^{*3} = 0.5 V$	V <sub>IN</sub> = 16.0 V	_	-	-0.68	mA	4
		CMOS output, $V_{DS}^{*3} = 0.5 V$	V <sub>IN</sub> = 2.5 V	2.50	-	_	mΑ	4
Output current "L"	Iron	Nch open-drain output, V <sub>DS</sub> * <sup>3</sup> = 0.5 V	V <sub>IN</sub> = 2.5 V	2.80	-	_	mA	4
Leakage current	I <sub>leakn</sub>	Nch open-drain output $V_{RO} = 36.0 V,$ $V_{IN} = 36.0 V$		_	_	2.0	μA	4
Detection response time*4	treset	_		-	140	-	μs	5
Release response time*5	<b>t</b> DELAY	C <sub>D</sub> = 3.3 nF		8.0	10.0	12.0	ms	5

\*1.  $-V_{DET(S)}$ : Set detection voltage,  $-V_{DET}$ : Actual detection voltage

\*2.  $+V_{DET(S)}$ : Set release voltage,  $+V_{DET}$ : Actual release voltage

\*3. V<sub>DS</sub>: Drain-to-source voltage of the output transistor

\*4. The time period from when the pulse voltage of  $-V_{DET(S)} + 1.0 \text{ V} \rightarrow 2.5 \text{ V}$  is applied to the VIN pin within 3.0 V  $\leq -V_{DET(S)} < 3.5 \text{ V}$  or the pulse voltage of  $-V_{DET(S)} + 1.0 \text{ V} \rightarrow -V_{DET(S)} - 1.0 \text{ V}$  is applied to the VIN pin within 3.5 V  $\leq -V_{DET(S)} \leq 14.6 \text{ V}$  until V<sub>RO</sub> reaches 50% of either V<sub>IN</sub> or V<sub>OUT</sub>.

\*5. The time period from when the pulse voltage of 2.5 V  $\rightarrow$  +V<sub>DET(S)</sub> + 1.0 V is applied to the VIN pin within 3.0 V  $\leq$  +V<sub>DET(S)</sub> < 3.5 V or the pulse voltage of +V<sub>DET(S)</sub> - 1.0 V  $\rightarrow$  +V<sub>DET(S)</sub> + 1.0 V is applied to the VIN pin within 3.5 V  $\leq$  +V<sub>DET(S)</sub>  $\leq$  14.6 V until V<sub>RO</sub> reaches 50% of either V<sub>IN</sub> or V<sub>OUT</sub>.

#### 3. Overall

Table 10

 $(T_j = -40^{\circ}C \text{ to } +125^{\circ}C \text{ unless otherwise specified})$ 

			(1) = -+0 0 10	120 0				oomoa)
Item	Symbol	Condition		Min.	Тур.	Max.	Unit	Test Circuit
Current			S-19316 Series A type	_	2.2	4.7	μA	6
consumption	ISS1		S-19316 Series B type	-	2.2	5.0	μA	6

**\*1.**  $V_{OUT(S)}$ : Set output voltage

\*2. +V<sub>DET(S)</sub>: Set release voltage

# Test Circuits



Figure 11 Test Circuit 5

\*1. Only S-19316 Series A type

Figure 12 Test Circuit 6

# Standard Circuit

#### 1. S-19316 Series A type



- \*1.  $C_{IN}$  is a capacitor for stabilizing the input.
- \*2.  $C_L$  is a capacitor for stabilizing the output.
- \*3.  $C_D$  is the delay time adjustment capacitor.
- \*4.  $R_{extR}$  is the external pull-up resistor for the reset output pin.

Figure 13

#### 2. S-19316 Series B type



- \*1.  $C_{IN}$  is a capacitor for stabilizing the input.
- \*2.  $C_L$  is a capacitor for stabilizing the output.
- \*3. C<sub>D</sub> is the delay time adjustment capacitor.

#### Figure 14

Caution The above connection diagrams and constants will not guarantee successful operation. Perform thorough evaluation including the temperature characteristics with an actual application to set the constants.

# ■ Condition of Application

Input capacitor (C<sub>IN</sub>):A ceramic capacitor with capacitance of 1.0  $\mu$ F or more is recommended.Output capacitor (C<sub>L</sub>):A ceramic capacitor with capacitance of 1.0  $\mu$ F or more is recommended.Delay time adjustment capacitor (C<sub>D</sub>):A ceramic capacitor with capacitance of 0.1 nF or more is recommended.

Caution Generally, in a voltage regulator, an oscillation may occur depending on the selection of the external parts. Perform thorough evaluation including the temperature characteristics with an actual application using the above capacitors to confirm no oscillation occurs.

# ■ Selection of Input Capacitor (C<sub>IN</sub>) and Output Capacitor (C<sub>L</sub>)

The S-19316 Series requires  $C_L$  between the VOUT pin and the VSS pin for phase compensation.

The operation is stabilized by a ceramic capacitor with capacitance of 1.0  $\mu$ F or more. When using an OS capacitor, a tantalum capacitor or an aluminum electrolytic capacitor, the capacitance also must be 1.0  $\mu$ F or more. However, an oscillation may occur depending on the equivalent series resistance (ESR).

Moreover, the S-19316 Series requires C<sub>IN</sub> between the VIN pin and the VSS pin for a stable operation.

Generally, an oscillaiton may occur when a voltage regulator is used under the conditon that the impedance of the power supply is high.

Note that the output voltage ( $V_{OUT}$ ) transient characteristics varies depending on the capacitance of  $C_{IN}$  and  $C_L$  and the value of ESR.

Caution Perform thorough evaluation including the temperature characteristics with an actual application to select C<sub>IN</sub> and C<sub>L</sub>.

# ■ Selection of Delay Time Adjustment Capacitor (C<sub>D</sub>)

In the S-19316 Series, the delay time adjustment capacitor (C<sub>D</sub>) is necessary between the CD pin and the VSS pin to adjust the release delay time (t<sub>DELAY</sub>) of the detector. Refer to "2. 2 Delay circuit" of "2. Detector block" in "■ Operation" for details.

# Caution Perform thorough evaluation including the temperature characteristics with an actual application to select C<sub>D</sub>.

# Explanation of Terms

#### 1. Regulator block

#### 1.1 Low dropout voltage regulator

This is a voltage regulator which made dropout voltage small by its built-in low on-resistance output transistor.

#### 1. 2 Output voltage (Vout)

This voltage is output at an accuracy of  $\pm 2.0\%$  or  $\pm 0.03$  V<sup>\*2</sup> when the input voltage, the output current and the temperature are in a certain condition<sup>\*1</sup>.

- \*1. Differs depending on the product.
- \*2. When  $V_{OUT} < 1.5 \text{ V}$ :  $\pm 0.03 \text{ V}$ , when  $V_{OUT} \ge 1.5 \text{ V}$ :  $\pm 2.0\%$

Caution If the certain condition is not satisfied, the output voltage may exceed the accuracy range of ±2.0% or ±0.03 V. Refer to "1. Regulator block" in "■ Electrical Characteristics" and "1. Regulator block" in "■ Characteristics (Typical Data)" for details.

# 1.3 Line regulation $\left(\frac{\Delta V_{OUT1}}{\Delta V_{IN} \bullet V_{OUT}}\right)$

Indicates the dependency of the output voltage against the input voltage. That is, the value shows how much the output voltage changes due to a change in the input voltage after fixing output current constant.

#### 1. 4 Load regulation (ΔV<sub>OUT2</sub>)

Indicates the dependency of the output voltage against the output current. That is, the value shows how much the output voltage changes due to a change in the output current after fixing input voltage constant.

#### 1. 5 Dropout voltage (Vdrop)

Indicates the difference between input voltage (V<sub>IN1</sub>) and the output voltage when the output voltage becomes 98% of the output voltage value (V<sub>OUT3</sub>) at V<sub>IN</sub> = 4.0 V (1.0 V  $\leq$  V<sub>OUT(S)</sub> < 2.0 V) or V<sub>IN</sub> = V<sub>OUT(S)</sub> + 2.0 V (2.0 V  $\leq$  V<sub>OUT(S)</sub>  $\leq$  5.3 V) after the input voltage (V<sub>IN</sub>) is decreased gradually.

 $V_{drop} = V_{IN1} - (V_{OUT3} \times 0.98)$ 

#### 2. Detector block

#### 2.1 Detection voltage (-VDET)

The detection voltage is a voltage at which the output of the RO pin turns to "L".

The detection voltage varies slightly among products of the same specification. The variation of detection voltage between the specified minimum ( $-V_{DET}$  min.) and the maximum ( $-V_{DET}$  max.) is called the detection voltage range (Refer to **Figure 15**, **Figure 17**).

#### 2. 2 Release voltage (+VDET)

The release voltage is a voltage at which the output of the RO pin turns to "H".

The release voltage varies slightly among products of the same specification. The variation of release voltage between the specified minimum ( $+V_{DET}$  min.) and the maximum ( $+V_{DET}$  max.) is called the release voltage range (Refer to **Figure 16**, **Figure 18**).



Figure 15 Detection Voltage (S-19316 Series A type)



Figure 17 Detection Voltage (S-19316 Series B type)



Figure 16 Release Voltage (S-19316 Series A type)





#### 2. 3 Hysteresis width (V<sub>HYS</sub>)

The hysteresis width is the voltage difference between the detection voltage and the release voltage. Setting the hysteresis width between the detection voltage and the release voltage prevents malfunction caused by noise on the pin voltage in the detection status.

# Operation

#### 1. Regulator block

#### 1.1 Basic operation

Figure 19 shows the block diagram of the regulator block to describe the basic operation.

The error amplifier compares the feedback voltage ( $V_{fb}$ ) whose output voltage ( $V_{OUT}$ ) is divided by the feedback resistors ( $R_s$  and  $R_f$ ) with the reference voltage ( $V_{ref}$ ). The error amplifier controls the output transistor, consequently, the regulator starts the operation that keeps  $V_{OUT}$  constant without the influence of the input voltage ( $V_{IN}$ ).



\*1. Parasitic diode



#### 1.2 Output transistor

In the S-19316 Series, a low on-resistance P-channel MOS FET is used between the VIN pin and the VOUT pin as the output transistor. In order to keep  $V_{OUT}$  constant, the on-resistance of the output transistor varies appropriately according to the output current ( $I_{OUT}$ ).

Caution Since a parasitic diode exists between the VIN pin and the VOUT pin due to the structure of the transistor, the IC may be damaged by a reverse current if  $V_{OUT}$  becomes higher than  $V_{IN}$ . Therefore, be sure that  $V_{OUT}$  does not exceed  $V_{IN} + 0.3$  V.

#### 1. 3 Overcurrent protection circuit

The S-19316 Series has a built-in overcurrent protection circuit to limit the overcurrent of the output transistor. When the VOUT pin is shorted to the VSS pin, that is, at the time of the output short-circuit, the output current is limited to 24 mA typ. due to the overcurrent protection circuit operation. The S-19316 Series restarts regulating when the output transistor is released from the overcurrent status.

# Caution This overcurrent protection circuit does not work as for thermal protection. For example, when the output transistor keeps the overcurrent status long at the time of output short-circuit or due to other reasons, pay attention to the conditions of the input voltage and the load current so as not to exceed the power dissipation.

#### 1.4 Thermal shutdown circuit

The S-19316 Series has a built-in thermal shutdown circuit to limit overheating. When the junction temperature increases to 160°C typ., the thermal shutdown circuit becomes the detection status, and the regulating is stopped. When the junction temperature decreases to 135°C typ., the thermal shutdown circuit becomes the release status, and the regulator is restarted.

If the thermal shutdown circuit becomes the detection status due to self-heating, the regulating is stopped and  $V_{OUT}$  decreases. For this reason, the self-heating is limited and the temperature of the IC decreases. The thermal shutdown circuit becomes release status when the temperature of the IC decreases, and the regulating is restarted thus the self-heating is generated again. Repeating this procedure makes the waveform of  $V_{OUT}$  into a pulse-like form. This phenomenon continues unless decreasing either or both of the input voltage and the output current in order to reduce the internal power consumption, or decreasing the ambient temperature. Note that the product may suffer physical damage such as deterioration if the above phenomenon occurs continuously.

Caution If a large load current flows during the restart process of regulating after the thermal shutdown circuit changes to the release status from the detection status, the thermal shutdown circuit becomes the detection status again due to self-heating, and a problem may happen in the restart of regulating. A large load current, for example, occurs when charging to the CL whose capacitance is large.

Perform thorough evaluation including the temperature characteristics with an actual application to select  $C_L$ .

VOUT Pin Voltage						
Constant value <sup>*2</sup>						
Pulled down to Vss*3						

Table 11

\*1. Junction temperature

\*2. The constant value is output due to the regulating based on the set output voltage value.

\*3. The VOUT pin voltage is pulled down to  $V_{SS}$  due to the feedback resistors ( $R_s$  and  $R_f$ ) and a load.

#### 2. Detector block

#### 2.1 Basic operation

#### 2. 1. 1 S-19316 Series A type

(1) When the input voltage (V<sub>IN</sub>) is release voltage (+V<sub>DET</sub>) of the detector or higher, the Nch transistor (N1) is off, and the RO pin output is "H".

Since the Nch transistor (N2) is off, the input voltage to the comparator is  $\frac{(R_B + R_C) \bullet V_{IN}}{R_A + R_B + R_C}$ .

(2) Even if V<sub>IN</sub> decreases to +V<sub>DET</sub> or lower, the RO pin output is "H" when V<sub>IN</sub> is the detection voltage (-V<sub>DET</sub>) or higher. When V<sub>IN</sub> is -V<sub>DET</sub> (point A in **Figure 21**) or lower, N1 of output stage is on, and the RO pin output is "L".

At this time, N2 is on, and the input voltage to the comparator is  $\frac{R_B \bullet V_{IN}}{R_A + R_B}$ .

- (3) When V<sub>IN</sub> further decreases to the IC's minimum operation voltage or lower, the RO pin output is unstable.
- (4) When V<sub>IN</sub> increases and is the IC's minimum operation voltage or higher, the RO pin output is "L". Moreover, even if V<sub>IN</sub> exceeds –V<sub>DET</sub>, the RO pin output is "L" when V<sub>IN</sub> is lower than +V<sub>DET</sub>.
- (5) When V<sub>IN</sub> further increases to +V<sub>DET</sub> (point B in Figure 21) or higher, the delay circuit operates. The RO pin output is "H" after the elapse of the release delay time (t<sub>DELAY</sub>).



\*1. Parasitic diode

Figure 20 Operation



Figure 21 Timing Chart

#### 2. 1. 2 S-19316 Series B type

(1) When the input voltage (V<sub>IN</sub>) is release voltage (+V<sub>DET</sub>) of the detector or higher, the Pch transistor (P1) is on, the Nch transistor (N1) is off, and the RO pin output is "H".

Since the Nch transistor (N2) is off, the input voltage to the comparator is  $\frac{(R_B + R_C) \bullet V_{IN}}{R_A + R_B + R_C}$ .

(2) Even if V<sub>IN</sub> decreases to +V<sub>DET</sub> or lower, the RO pin output is "H" when V<sub>IN</sub> is the detection voltage (−V<sub>DET</sub>) or higher. When V<sub>IN</sub> decreases to −V<sub>DET</sub> (point A in **Figure 23**) or lower, P1 of output stage is off, N1 of output stage is on, and the RO pin output is "L".

At this time, N2 is on, and the input voltage to the comparator is  $\frac{R_B \bullet V_{IN}}{R_A + R_B}$ 

- (3) When V<sub>IN</sub> further decreases to the IC's minimum operation voltage or lower, the RO pin output is unstable.
- (4) When V<sub>IN</sub> increases to the IC's minimum operation voltage or higher, the RO pin output is "L". Moreover, even if V<sub>IN</sub> exceeds –V<sub>DET</sub>, the RO pin output is "L" when V<sub>IN</sub> is lower than +V<sub>DET</sub>.
- (5) When V<sub>IN</sub> further increases to +V<sub>DET</sub> (point B in **Figure 23**) or higher, the delay circuit operates. The RO pin output is "H" after the elapse of the release delay time (t<sub>DELAY</sub>).



\*1. Parasitic diode

Figure 22 Operation



#### 2.2 Delay circuit

The delay circuit has a function that adjusts the release delay time ( $t_{DELAY}$ ) from when the input voltage ( $V_{IN}$ ) reaches the release voltage ( $+V_{DET}$ ) of the detector to when the output from the RO pin inverts.

 $t_{DELAY}$  is determined by the delay coefficient, the delay time adjustment capacitor ( $C_D$ ) and the release delay time when the CD pin is open ( $t_{DELAY0}$ ). It is calculated by the equation below.

- . . . .

 $t_{DELAY}$  [ms] = Delay coefficient  $\times$  C<sub>D</sub> [nF] +  $t_{DELAY0}$  [ms]

Table 12						
lun etien Teneneneture	Delay Coefficient					
Junction Temperature	Min.	Тур.	Max.			
$T_j = -40^{\circ}C \text{ to } +125^{\circ}C$	2.76	3.00	3.28			

Та	ble	1	3
ıα	nie		3

	Release Delay Time				
Junction Temperature	when CD Pin is Open (t <sub>DELAY0</sub> )				
	Min.	Тур.	Max.		
$T_j = -40^{\circ}C \text{ to } +125^{\circ}C$	0.03 ms	0.07 ms	0.36 ms		

- Caution 1. The above equation will not guarantee successful operation. Perform thorough evaluation including the temperature characteristics with an actual application to set the constants.
  - 2. Mounted board layout should be made in such a way that no current flows into or flows from the CD pin since the impedance of the CD pin is high, otherwise correct delay time cannot be provided.
  - 3. There is no limit for the capacitance of C<sub>D</sub> as long as the leakage current of the capacitor can be ignored against the built-in constant current value (approximately 350 nA). The leakage current may cause error in delay time. When the leakage current is larger than the built-in constant current, no detect or release takes place.

#### 2. 3 VIN drop during release delay time (reference)

**Figure 24** shows the relation between pulse width (t<sub>PW</sub>) and V<sub>IN</sub> lower limit (V<sub>DROP</sub>) where a release signal can be output after the normal release delay time has elapsed when the VIN pin voltage instantaneously drops during release delay time.





- Caution 1. Figure 24 shows the input voltage conditions when a release signal is output after the normal release delay time has elapsed. When this is within the inhibited area, release may erroneously be executed before the delay time completes.
  - 2. When the VIN pin voltage is within the inhibited areas shown in Figure 24 during release delay time, input 0 V to the VIN pin then restart the detector.

# Precautions

- Generally, when a voltage regulator is used under the condition that the impedance of the power supply is high, an
  oscillation may occur. Perform thorough evaluation including the temperature characteristics with an actual
  application to select C<sub>IN</sub>.
- Generally, in a voltage regulator, an oscillation may occur depending on the selection of the external parts. The following use conditions are recommended in the S-19316 Series; however, perform thorough evaluation including the temperature characteristics with an actual application to select C<sub>IN</sub> and C<sub>L</sub>.

Input capacitor ( $C_{IN}$ ): A ceramic capacitor with capacitance of 1.0  $\mu$ F or more is recommended. Output capacitor ( $C_L$ ): A ceramic capacitor with capacitance of 1.0  $\mu$ F or more is recommended.

- Generally, in a voltage regulator, the values of an overshoot and an undershoot in the output voltage vary
  depending on the variation factors of input voltage start-up, input voltage fluctuation, load fluctuation etc., or the
  capacitance of C<sub>IN</sub> or C<sub>L</sub> and the value of the equivalent series resistance (ESR), which may cause a problem to the
  stable operation. Perform thorough evaluation including the temperature characteristics with an actual application to
  select C<sub>IN</sub> and C<sub>L</sub>.
- Generally, in a voltage regulator, an overshoot may occur in the output voltage momentarily if the input voltage steeply changes when the input voltage is started up, the input voltage fluctuates, etc. Perform thorough evaluation including the temperature characteristics with an actual application to confirm no problems happen.
- Generally, in a voltage regulator, if the VOUT pin is steeply shorted with GND, a negative voltage exceeding the
  absolute maximum ratings may occur in the VOUT pin due to resonance phenomenon of the inductance and the
  capacitance including C<sub>L</sub> on the application. The resonance phenomenon is expected to be weakened by inserting
  a series resistor into the resonance path, and the negative voltage is expected to be limited by inserting a
  protection diode between the VOUT pin and the VSS pin.
- If the input voltage is started up steeply under the condition that the capacitance of C<sub>L</sub> is large, the thermal shutdown circuit may be in the detection status by self-heating due to the charge current to C<sub>L</sub>.
- Make sure of the conditions for the input voltage, output voltage and the load current so that the internal loss does not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- When considering the output current value that the IC is able to output, make sure of the output current value specified in **Table 8** in "■ **Electrical Characteristics**" and footnote \*4 of the table.
- Wiring patterns on the application related to the VIN pin, the VOUT pin and the VSS pin should be designed so that the impedance is low. When mounting C<sub>IN</sub> between the VIN pin and the VSS pin and C<sub>L</sub> between the VOUT pin and the VSS pin, connect the capacitors as close as possible to the respective destination pins of the IC.
- In the package equipped with heat sink of backside, mount the heat sink firmly. Since the heat radiation differs according to the condition of the application, perform thorough evaluation with an actual application to confirm no problems happen.
- ABLIC Inc. claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

# ■ Characteristics (Typical Data)

#### 1. Regulator block

1.1 Output voltage vs. Output current (When load current increases) (Ta = +25°C)





# 1. 1. 2 VOUT = 3.3 V



- **Remark** In determining the output current, attention should be paid to the following.
  - 1. The minimum output current value and footnote \*4 of Table 8 in "■ Electrical Characteristics"
  - 2. Power dissipation



#### 1. 2. 2 Vout = 3.3 V

1.3 Dropout voltage vs. Output current



1.4 Dropout voltage vs. Junction temperature





1. 4. 2 VOUT = 5.0 V





#### 1. 5 Output voltage vs. Junction temperature







ABLIC Inc.

#### 2. Detector block







2. 2 Nch transistor output current vs. VDs

#### 2. 2. 1 S-19316 Series A type



2. 2. 2 S-19316 Series B type

2. 1. 2 -V<sub>DET</sub> = 4.4 V, +V<sub>DET</sub> = 4.7 V

0

25

50

Tj [°C]

+VDET

-Vdet

75 100 125 150

5.0

4.8

4.6

4.4

4.2

4.0

-40 -25

Σ

-Vdet, +Vdet



2. 3 Pch transistor output current vs. V<sub>DS</sub> (S-19316 Series B type)



Remark VDS: Drain-to-source voltage of the output transistor



#### 2.4 Nch transistor output current vs. Power supply voltage





Remark VDS: Drain-to-source voltage of the output transistor

#### 2. 6 Minimum operation voltage vs. Power supply voltage / Output voltage (S-19316 series A type)



2.7 Dynamic response vs. RO pin capacitance



Caution The above connection diagram and constants will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.



2. 7. 2 S-19316 Series B type



# ABLIC Inc.

#### 3. Overall

- 3.1 Current consumption vs. Input voltage (No load)
  - 3. 1. 1 S-19316 Series A type
    - (1) V<sub>OUT</sub> = 1.8 V



(2) V<sub>OUT</sub> = 3.3 V



(3) V<sub>OUT</sub> = 5.0 V









#### 3. 1. 2 S-19316 Series B type



(2) V<sub>OUT</sub> = 3.3 V













#### 3. 2 Current consumption vs. Junction temperature

#### 3. 2. 1 S-19316 Series A type





	(2)		т <b>= 3.</b> Det =	<b>3 V</b> 3.0 V	+Vn	<sub>ЕТ</sub> = З	3.2 V.	V <sub>IN</sub> =	5.3 \	,
	10.0				,		,			ĺ
	8.0									
lss [µA]	6.0									
ss [	4.0									
	2.0									
	0.0									
	-4	0 –2	25 (	) 2		0 7 [°C]	5 10	00 12	25 15	50



#### 3.3 Current consumption during release delay time vs. Junction temperature

#### 3. 3. 2 S-19316 Series B type

3. 3. 1 S-19316 Series A type









#### ABLIC Inc.



3. 4 Current consumption vs. Output current (Ta = +25°C)



# Reference Data

## 1. Transient response characteristics when input (Ta = +25°C)



- 3. Load dump characteristics (Ta = +25°C)
- 3.1 V<sub>OUT</sub> = 5.0 V



4. Example of equivalent series resistance vs. Output current characteristics (Ta = +25°C)





\*1. CL: TDK Corporation CGA4J3X8R1C105K (1.0  $\mu$ F)

Figure 30

Figure 31

#### 5. Release delay time vs. CD pin capacitance (Without output pin capacitance)



6. Release delay time vs. Junction temperature



\*1. V<sub>IH</sub> = +V<sub>DET(S)</sub> + 1.0 V

\*2. When 3.0 V  $\leq$  +V<sub>DET(S)</sub> < 3.5 V, V<sub>IL</sub> = 2.5 V When 3.5 V  $\leq$  +V\_{DET(S)}  $\leq$  14.6 V, VIL = +V\_{DET(S)} - 1.0 V

Figure 32 Test Condition of Release Delay Time

Figure 33 Test Circuit of Release Delay Time

Caution The above connection diagram and constants will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constants.

# Power Dissipation

SOT-89-5





Ambient temperature (Ta) [°C]

Board	Power Dissipation (P <sub>D</sub> )
А	1.05 W
В	1.49 W
С	_
D	2.72 W
E	3.57 W

	5 –		-	-		Tj =	+150°	Сm	ax.
5		E							
Power dissipation (P <sub>D</sub> ) [W]		С							
oation	3 -	D							
issip	2				$\square$				_
ower d	1 =	В							
ď		A					•		
	00	2	5 5	0 7	75 10	0 12	25 1	50	175
			Amb	ient ter	nperati	ure (Ta	ı) [°C]		

Board	Power Dissipation (P <sub>D</sub> )
А	0.79 W
В	1.11 W
С	3.21 W
D	3.13 W
E	4.17 W

## SOT-23-5



Board	Power Dissipation (P <sub>D</sub> )
А	0.65 W
В	0.78 W
С	_
D	_
E	_
# **SOT-89-5** Test Board

#### (1) Board A



#### (2) Board B



#### (3) Board D



#### (4) Board E





enlarged view

ltem Sp		pecification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

Item	S	Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

Item	S	pecification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Pattern for heat radiation: 2000mm <sup>2</sup> t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

Item	S	Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Pattern for heat radiation: 2000mm <sup>2</sup> t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm

#### No. SOT895-A-Board-SD-1.0

#### ABLIC Inc.

( ) IC Mount Area

# HTMSOP-8 Test Board

) IC Mount Area

#### (1) Board A



	Specification
	114.3 x 76.2 x t1.6
	FR-4
ayer	2
1	Land pattern and wiring for testing: t0.070
2	-
3	-
4	74.2 x 74.2 x t0.070
	-
	1 2 3

#### (2) Board B



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

### (3) Board C



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil la	ayer	4
	1	Land pattern and wiring for testing: t0.070
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm

≣∎≣

enlarged view

#### No. HTMSOP8-A-Board-SD-1.0

# **HTMSOP-8** Test Board

Item

Size [mm]

### 🔵 IC Mount Area

Specification

#### (4) Board D





114.3 x 76.2 x t1.6



enlarged view

#### (5) Board E



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
	1	Pattern for heat radiation: 2000mm <sup>2</sup> t0.070
Copper foil layer [mm]	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		Number: 4 Diameter: 0.3 mm



enlarged view

#### No. HTMSOP8-A-Board-SD-1.0

# SOT-23-3/3S/5/6 Test Board

) IC Mount Area

### (1) Board A



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		2
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	-
	3	-
	4	74.2 x 74.2 x t0.070
Thermal via		-

#### (2) Board B



Item		Specification
Size [mm]		114.3 x 76.2 x t1.6
Material		FR-4
Number of copper foil layer		4
Copper foil layer [mm]	1	Land pattern and wiring for testing: t0.070
	2	74.2 x 74.2 x t0.035
	3	74.2 x 74.2 x t0.035
	4	74.2 x 74.2 x t0.070
Thermal via		-

No. SOT23x-A-Board-SD-2.0







No. UP005-A-P-SD-2.0

TITLE	SOT895-A-PKG Dimensions		
No.	UP005-A-P-SD-2.0		
ANGLE	$\oplus \in $		
UNIT	mm		
	ABLIC Inc.		













No. FP008-A-L-SD-2.0

TITLE	HTMSOP8-A -Land Recommendation
No.	FP008-A-L-SD-2.0
ANGLE	
UNIT	mm
	ABLIC Inc.







No. MP005-A-P-SD-1.3

TITLE	SOT235-A-PKG Dimensions
No.	MP005-A-P-SD-1.3
ANGLE	
UNIT	mm
ABLIC Inc.	





### **Disclaimers (Handling Precautions)**

- 1. All the information described herein (product data, specifications, figures, tables, programs, algorithms and application circuit examples, etc.) is current as of publishing date of this document and is subject to change without notice.
- The circuit examples and the usages described herein are for reference only, and do not guarantee the success of any specific mass-production design.
  ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the reasons other than the products described herein (hereinafter "the products") or infringement of third-party intellectual property right and any other right due to the use of the information described herein.
- 3. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by the incorrect information described herein.
- 4. Be careful to use the products within their ranges described herein. Pay special attention for use to the absolute maximum ratings, operation voltage range and electrical characteristics, etc. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by failures and / or accidents, etc. due to the use of the products outside their specified ranges.
- 5. Before using the products, confirm their applications, and the laws and regulations of the region or country where they are used and verify suitability, safety and other factors for the intended use.
- 6. When exporting the products, comply with the Foreign Exchange and Foreign Trade Act and all other export-related laws, and follow the required procedures.
- 7. The products are strictly prohibited from using, providing or exporting for the purposes of the development of weapons of mass destruction or military use. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by any provision or export to the person or entity who intends to develop, manufacture, use or store nuclear, biological or chemical weapons or missiles, or use any other military purposes.
- 8. The products are not designed to be used as part of any device or equipment that may affect the human body, human life, or assets (such as medical equipment, disaster prevention systems, security systems, combustion control systems, infrastructure control systems, vehicle equipment, traffic systems, in-vehicle equipment, aviation equipment, aerospace equipment, and nuclear-related equipment), excluding when specified for in-vehicle use or other uses by ABLIC, Inc. Do not apply the products to the above listed devices and equipments. ABLIC Inc. is not liable for any losses, damages, claims or demands caused by unauthorized or unspecified use of the products.
- 9. In general, semiconductor products may fail or malfunction with some probability. The user of the products should therefore take responsibility to give thorough consideration to safety design including redundancy, fire spread prevention measures, and malfunction prevention to prevent accidents causing injury or death, fires and social damage, etc. that may ensue from the products' failure or malfunction.

The entire system in which the products are used must be sufficiently evaluated and judged whether the products are allowed to apply for the system on customer's own responsibility.

- 10. The products are not designed to be radiation-proof. The necessary radiation measures should be taken in the product design by the customer depending on the intended use.
- 11. The products do not affect human health under normal use. However, they contain chemical substances and heavy metals and should therefore not be put in the mouth. The fracture surfaces of wafers and chips may be sharp. Be careful when handling these with the bare hands to prevent injuries, etc.
- 12. When disposing of the products, comply with the laws and ordinances of the country or region where they are used.
- 13. The information described herein contains copyright information and know-how of ABLIC Inc. The information described herein does not convey any license under any intellectual property rights or any other rights belonging to ABLIC Inc. or a third party. Reproduction or copying of the information from this document or any part of this document described herein for the purpose of disclosing it to a third-party is strictly prohibited without the express permission of ABLIC Inc.
- 14. For more details on the information described herein or any other questions, please contact ABLIC Inc.'s sales representative.
- 15. This Disclaimers have been delivered in a text using the Japanese language, which text, despite any translations into the English language and the Chinese language, shall be controlling.



2.4-2019.07